

UNITED STATES PATENT AND TRADEMARK OFFICE

BEFORE THE PATENT TRIAL AND APPEAL BOARD

APPLIED MATERIALS, INC.,
Petitioner,

v.

DEMARAY LLC,
Patent Owner.

Case IPR2021-00103
U.S. Patent No. 7,544,276

**PATENT OWNER'S UPDATED MANDATORY NOTICE
PURSUANT TO 37 C.F.R. § 42.8**

Mail Stop: PATENT BOARD
Patent Trial and Appeal Board
U.S. Patent and Trademark Office
P.O. Box 1450
Alexandria, VA 22313-1450

IPR2021-00103
Patent No. 7,544,276

Pursuant to 37 C.F.R. § 42.8, Patent Owner Demaray LLC (“Demaray” or “Patent Owner”) hereby submits the following Notice.

I. REAL PARTY-IN-INTEREST (Unchanged)

The real party-in-interest is Demaray LLC.

II. RELATED MATTERS (Changed)

Patent Owner identifies the following matters that may be deemed related pursuant to 37 C.F.R. § 42.8(b)(2):

- Demaray has asserted U.S. Patent No. 7,544,276 (“the ’276 patent”) in the following cases: *Demaray LLC v. Intel Corporation*, No. 6:20-cv-00634 (W.D. Tex) and *Demaray LLC v. Samsung Electronics Co., Ltd.*, No. 6:20-cv-00636 (W.D. Tex). The ’276 patent is also at issue in *Applied Materials, Inc. v. Demaray LLC*, No. 5-20-cv-05676 (N.D. Cal.) (terminated), and *Applied Materials, Inc. v. Demaray LLC*, No. 5-20-cv-09341 (N.D. Cal.).
- Petitioner Applied Materials, Inc. filed IPR petitions, IPR2021-00103 and IPR2021-00105, challenging U.S. Patent No. 7,544,276 (“the ’276 patent”). Institution of IPR2021-00103 was granted on May 11, 2021; Institution of IPR2021-0105 was denied on May 12, 2021

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- Petitioner Applied Materials, Inc. filed IPR petitions, IPR2021-00104 and IPR2021-00106, challenging related U.S. Patent No. 7,381,657 (“the ’657 patent”). Institution of IPR2021-00104 was granted on May 11, 2021; Institution of IPR2021-00106 was denied on May 11, 2021.
- Samsung Electronics Co., Ltd. filed IPR2021-1091 against the ’657 patent, requesting to be joined with IPR2021-00104, and IPR2021-01090 against the ’276 patent, requesting to be joined with IPR2021-00103.
- Intel Corporation filed IPR2021-01031 against the ’657 patent, requesting to be joined with IPR2021-00104, and IPR2021-01030 against the ’276 patent, requesting to be joined with IPR2021-00103.

III. LEAD AND BACK-UP COUNSEL (Changed)

LEAD COUNSEL	BACK-UP COUNSEL
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IV. SERVICE INFORMATION (Unchanged)

Please address all correspondence to the lead and back-up counsel as shown above. The Patent Owner consents to electronic service at DemarayIPRs@irell.com.

Dated: August 6, 2021

Respectfully submitted,

Hong Annita Zhong

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Demaray LLC

IPR2021-00103
Patent No. 7,544,276

CERTIFICATE OF SERVICE

Pursuant to 37 C.F.R. § 42.6, the undersigned certifies that on August 6, 2021, a copy of the foregoing document **PATENT OWNER'S UPDATED MANDATORY NOTICE** was served by electronic mail upon the following:

PAUL HASTINGS LLP

Naveen Modi, Reg. No. 46,224

Joseph E. Palys, Reg. No. 46,508

Howard Herr (*pro hac vice* admission to be requested)

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/Susan M. Langworthy/
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